## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kazuo Kanetsuna

Title: HEAT INSULATION PANEL SERVING ALSO AS

MOLD FORM, AND OUTER HEAT INSULATION

STRUCTURE

Docket No.: 41089

## PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Prior to the examination of the above-identified patent application, it is requested that the following amendments be made.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.